

曜凌光電股份有限公司

 住址: 42878 台中市大雅区科雅路 25 號 5F
 WEB: <u>http://www.Raystar-Optronics.com</u>

 5F., No.25, Keya Rd., Daya Dist., Taichung
 E-mail: <u>sales@raystar-optronics.com</u>

 City 428, Taiwan
 Tel:886-4-2565-0761
 Fax : 886-4-2565-0760

RFF700P-1IW-DBN

SPECIFICATION

CUSTOMER:

APPROVED BY

PCB VERSION

DATE

FOR CUSTOMER USE ONLY

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
Release DATE:			



Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2015/11/03		First issue
А	2016/01/21		Modify Static
			electricity test
В	2016/08/11		Modify Vibration test
С	2016/10/08		Modify Summary



Contents

- 1. Module Classification Information
- 2.Summary
- **3.General Specification**
- 4.Interface
- 5.Contour Drawing
- 6.Block Diagram
- 7. Absolute Maximum Ratings
- **8.**Electrical Characteristics
- 9.DC Characteristics
- **10.AC** Characteristics
- **11.Optical Characteristics**
- 12.Reliability
- 13.Initial Code For Reference
- 14.0ther



[®]RAYSTAR 1.Module Classification Information

R	F	F	70	0P	-	1	I	W	-	D	В	Ν
1	2	3	4	5	-	6	7	8	-	9	10	11

Item	Description								
1	R : Raystar Optronics Inc.								
2	Display Type : $F \rightarrow TFT$ Type, $J \rightarrow Custom TFT$								
	Solution: A: 128x160 B:320x234 C:320x240 D:480x234 E:480x272								
	F:800x	480	G:640x480	H:1024x6	600	J:240x320			
3	K:1280)x800	L:240x400	M:1024x7	768	N:128x128	O:480x800		
	P:640x	(320	Q:800x600	S:480x12	28	T:800x320			
4	Display Size : 7	'.0" TFT							
5	Version Code.								
	Model Type:								
	A : TFT LCD				6:	TFT+FR			
	E : TFT+FR+C	ONTRO	L BOARD		Н:	TFT+D/V B	OARD		
6	J:TFT+FR+A/I		RD		: -	TFT+FR+D/V	BOARD		
	N : TFT+FR+A/	D BOAF	RD+CONTROL	BOARD	B:	TFT+POWER	R BD		
		T+FR+POWER BOARD (DC TO DC)							
	1 : TFT+CONT	ROL B	OARD						
	Polarizer		nsmissive, W.						
	Туре,		ansmissive, W			Transmissive	, N.T,12:00		
7	Temperature		ansmissive,W.						
	range,		ansmissive, N.		Γ				
	View direction		ansmissive, W		о тг				
l .			ansmissive, Su	•					
			ansmissive, Su	•					
			ansmissive, Si ansmissive, Si	•					
			ED, White	-), High Light V	Vhite		
8	Backlight		FL, White			, riigit Ligitt v	Vinte		
9	Driver Method	D: Digi	ital A: Ana	0					
10	Interface				18 : A				
			Interface R thout TS	: RS232		JSB I: I20 buch panel	0		
11	те					•			
11	TS	C : capacitive touch panel capacitive touch panel (G-F-F) G : capacitive touch panel(G-G)							
		G·ca		paner(G-C	וב				



2.Summary

TFT 7.0" is a TN transmissive type color active matrix TFT liquid crystal display that use amorphous silicon TFT as switching devices. This module is a composed of a TFT_LCD module, It is usually designed for industrial application and this module follows RoHs.



3.General Specifications

- Size: 7.0 inch
- Dot Matrix: 800 x RGB x 480(TFT) dots
- Module dimension: 165.0(W) x 100.0(H) x 11.5(D) mm
- Active area: 154.08 x 85.92 mm
- Dot pitch: 0.0642 x 0.179 mm
- LCD type: TFT, Negative, Transmissive
- View Direction: 12 o'clock
- Gray Scale Inversion Direction: 6 o'clock
- Backlight Type: LED,Normally White
- Controller IC: RA8875
- Interface: Digital 8080 family MPU 8bit/16bit
- With /Without TP: Without TP
- Surface: Anti-Glare

*Color tone slight changed by temperature and driving voltage.



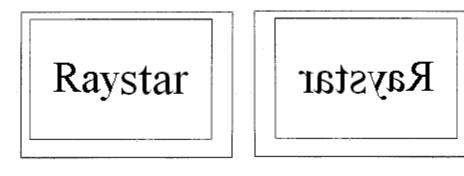
4.Interface

4.1. LCM PIN Definition								
Pin	Symbol	Function	Remar k					
1	GND	System ground pin of the IC.						
		Connect to system ground.						
2	VDD	Power Supply : +3.3V						
3	BLE	Backlight control signal , H: On \ L: Off						
4	RS	Data/Command select						
5	WR	Write strobe signal						
6	RD	Read strobe signal						
7	DB0	Data bus						
8	DB1	Data bus						
9	DB2	Data bus						
10	DB3	Data bus						
11	DB4	Data bus						
12	DB5	Data bus						
13	DB6	Data bus						
14	DB7	Data bus						
15	DB8	Data bus (When select 8bits Mode, this pin is NC)	Note1					
16	DB9	Data bus (When select 8bits Mode, this pin is NC)	Note1					
17	DB10	Data bus (When select 8bits Mode, this pin is NC)	Note1					
18	DB11	Data bus (When select 8bits Mode, this pin is NC)	Note1					
19	DB12	Data bus (When select 8bits Mode, this pin is NC)	Note1					
20	DB13	Data bus (When select 8bits Mode, this pin is NC)	Note1					
21	DB14	Data bus (When select 8bits Mode, this pin is NC)	Note1					
22	DB15	Data bus (When select 8bits Mode, this pin is NC)	Note1					
23	WAIT	Wait Signal Output(H:active)						
24	NC	No connect						
25	CS	Chip select						
26	RST	Hardware reset						
27	L/R	Left / right selection; Default L/R=H	Note 2,3					
28	U/D	Up/down selection; ; Default U/D=L	Note 2,3					
29	NC	No connect						
30	NC	No connect						
31	NC	No connect						
32	NC	No connect						
33	VLED-	Power for LED Driver IC(GND)						
34	VLED-	Power for LED Driver IC(GND)						
35	VLED+	Power for LED Driver IC(+5V)						
36	VLED+	Power for LED Driver IC(+5V)						
Nota	· When selec	t 8bit mode. DB0~DB7 be used. DB8~DB15 no connec	t					

Note1: When select 8bit mode, DB0~DB7 be used, DB8~DB15 no connect When select 16bit mode, DB0~DB15 be used Note 2: Selection of scanning mode

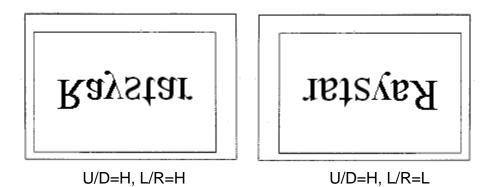
Setting of scar	n control input	Scanning direction			
U/D	L/R	Scanning direction			
GND	VDD	Up to down, left to right			
VDD	GND	Down to up, right to left			
GND	GND	Up to down, right to left			
VDD VDD		Down to up, left to right			

Note 3: Definition of scanning direction.Refer to the figure as below:



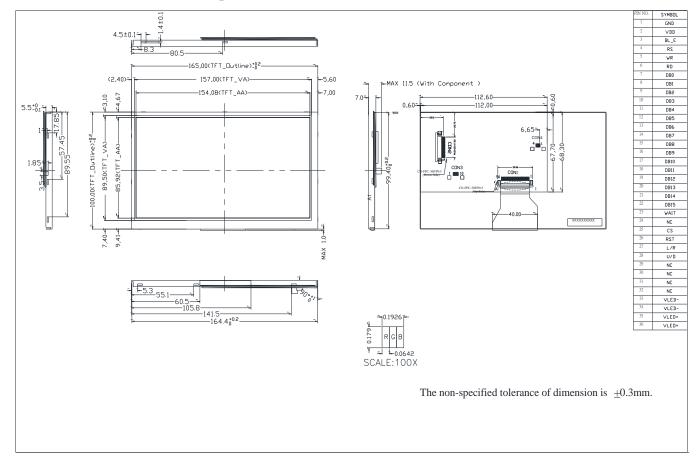
U/D=L, L/R=H

U/D=L, L/R=L



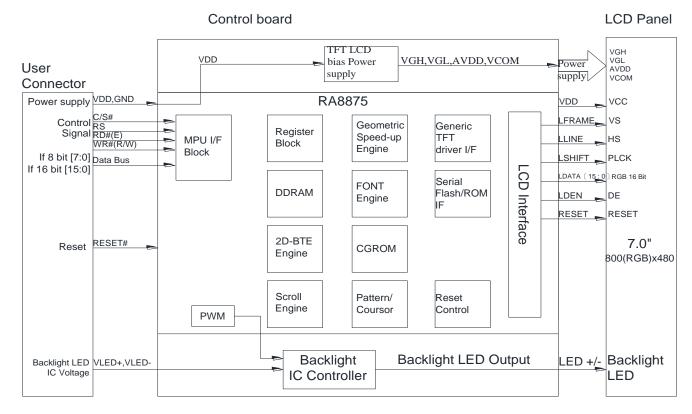


5.Contour Drawing





6.Block Diagram



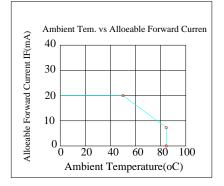


7. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	TOP	-20		+70	°C
Storage Temperature	TST	-30		+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. $\leq 60^{\circ}$ C, 90% RH MAX. Temp. $> 60^{\circ}$ C, Absolute humidity shall be less than 90% RH at 60° C





8.Electrical Characteristics

8.1. Operating conditions:

Item	Symbol	Condition	Min	Тур	Max	Unit	Remark
Supply Voltage For LCM	VDD	—	3.2	3.3	3.4	V	—
Supply Current For LCM	IDD		_	120	180	mA	Note1

Note 1 : This value is test for VDD=3.3V , Ta=25 $^\circ\!\!\mathbb{C}$ only

8.2. Backlight driving conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark
Operation Current For LED	VLED=5V	400	_	600	mA	Note 1,2
Driver						
Power Consumption	VLED=5V	2000	_	3000	mW	Note 1,2
Supply Voltage For LED Driver	VLED+	—	5		V	—
LED Life Time		_	50,000		Hr	Note 2,3,4

Note 1 : Base on VLED= 5V for the back light driver IC specification

Note 2 : Ta = 25 $^{\circ}$ C

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case



9.DC CHARATERISTICS

Parameter	Symbol		Rating	Unit	Condition	
Falameter	Symbol	Min	Тур	Max	Unit	Condition
Low level input voltage	VIL	GND	-	0.2 VDD	V	
High level input voltage	VIH	0.8 VDD	-	VDD	V	



10.AC CHARATERISTICS

10.1. Parallel I/F Protocol

The following timing charts are used to describe the timing specification of the standard 8080 and 6800 interfaces.

6800 - 8/16-bit Interface

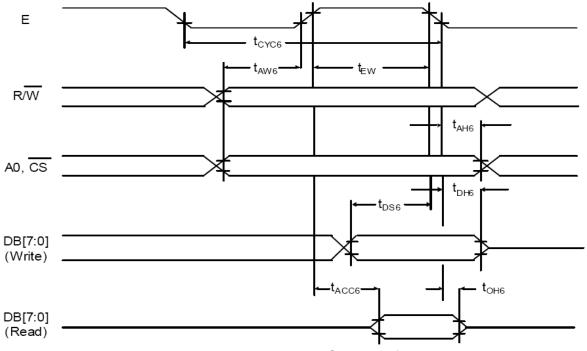


Figure 1: 6800 MCU Waveform

Symbol	Parameter	Rating	Rating		Symbol
Symbol	Falametei	Min.	Max	Unit	Symbol
tCYC6	Cycle time	50		ns	
tEW	Strobe Pulse width	20		ns	
tAW6	Address setup time	0		ns	
tAH6	Address hold time	10		ns	tc is one system clock
tDS6	Data setup time	20		ns	period: tc = 1/SYS_CLK
tDH6	Data hold time	10		ns	
tACC6	Data output access time	0	20	ns	
tOH6	Data output hold time	0	20	ns	



8080 - 8/16-bit Interface

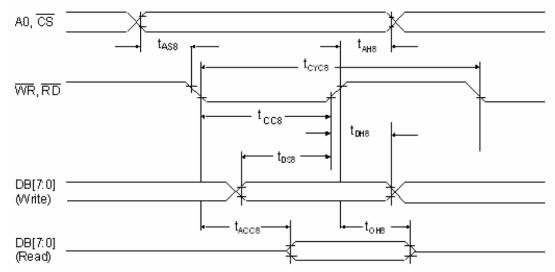


Figure 2: 8080 Waveform Table 2: 8080 MCU I/F Timing

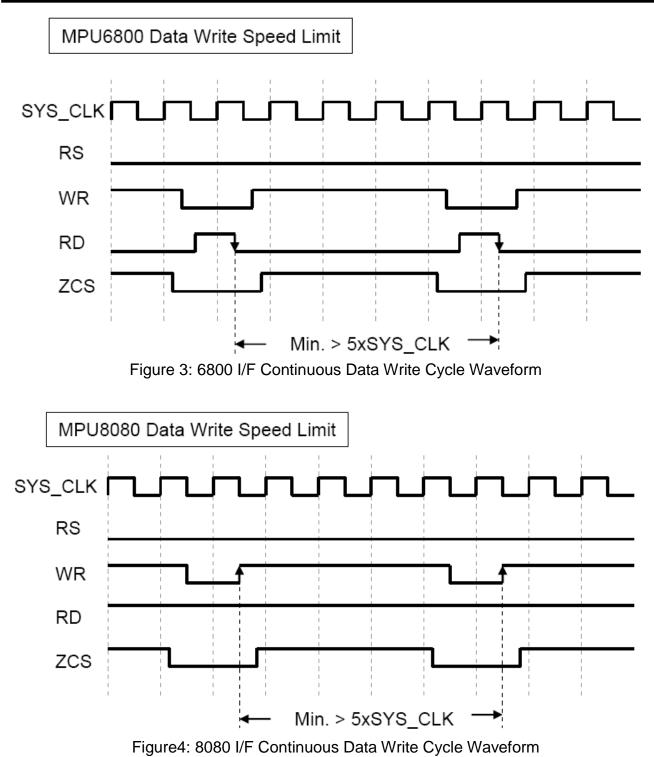
		-			
Symbol	Parameter	Rating		Unit	Symbol
		Min.	Max.	Onic	Cymbol
tCYC8	Cycle time	50		ns	
tCC8	Strobe Pulse width	20		ns	
tAS8	Address setup time	0		ns	tc is one system
tAH8	Address hold time	10		ns	clock period:
tDS8	Data setup time	20		ns	tc = 1/SYS_CLK
tDH8	Data hold time	10		ns	
tACC8	Data output access time	0	20	ns	
tOH8	Data output hold time	0	20	ns	



The data bus width of RA8875 can be selected to 8-bit/16-bit by setting the Bit [1:0] of SYSR. When Bit [1:0] of SYSR is cleared to "00", then the data bus is 8-bit. If Bit [1:0] of SYSR is set to

"11", then the data transition is set as16-bit. No matter what type of MCU I/F is selected (6800/8080), both of them can be changed the bus width when need. But if the 8-bit is used, it needs double transmission time than 16-bit bus and all of the registers must be accessed by 8-bit data.

The continuous data write speed determines the display update speed. The cycle-to-cycle interval must be larger than 4 times of system clock period. Over the specification may cause the data lose or function fail. Please refer to Figure 6-5 and Figure 6-6 for waveform detail. In order to reduce the transmission interference between MCU interface and RA8875, It is suggested that a small capacitor to the GND should be added at the signal of CS#, RD#, and WR #. If using cable to connect MCU and RA8875, please keep the cable length less than 20cm. Otherwise it's suggested to add 1~10Kohm pull-up resistors on pins CS#, RD#, WR# and RS.





10.2. Data transfer order Setting

MCU Data Bus 8-Bit

The following illustration is used for 16-bit MCU.

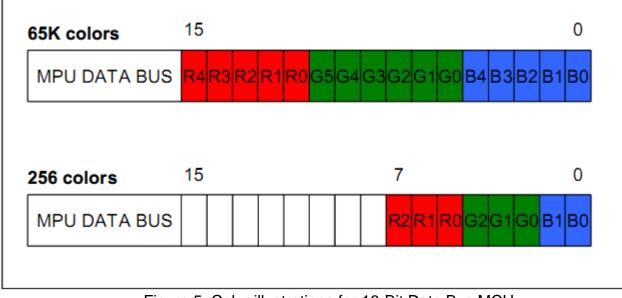


Figure 5: Color illustrations for 16-Bit Data Bus MCU

10.3. Register Depiction

Please consult the spec of RA8875 Please consult the spec of FOCALTECH FT5x06



11.Optical Characteristics

Item		Symbol	Condition.	Min	Тур.	Max.	Unit	Remark	
Pooponeo timo		Tr	θ=0°、Φ=0°	-	10	20	.ms	Note 3	
Response time		Tf	θ=0、Φ=0	-	15	30	.ms	NULE 3	
Contrast ratio		CR	At optimized viewing angle	400	500	-	-	Note 4	
Color	White	Wx	θ=0°、Φ=0	0.26	0.31	0.36		Noto 2 5 6	
Chromaticity	vvnite	Wy	$\theta = 0$, $\Psi = 0$	0.28	0.33	0.38		Note 2,5,6	
Viewing angle	Viewing angle Hor.	ΘR		60	70	-			
(Gray Scale		ΘL CR≧10	60	70	-	Dog	Note 1		
Inversion	Var	ΦT	OR = 10	40	50	-	Deg.	NOLE I	
Direction)	Ver.	ΦВ		60	70	-			
Brightness		-	-	350	460	-	cd/m ²	Center of display	

Ta=25±2°C, VLED / ILED= 5V / 400mA

Note 1: Definition of viewing angle range

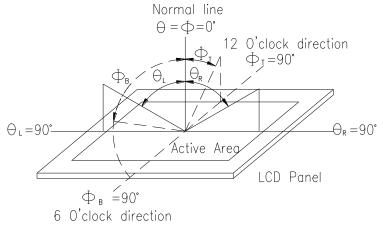
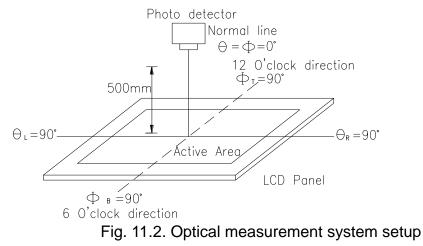


Fig. 11.1. Definition of viewing angle

Note 2: Test equipment setup:

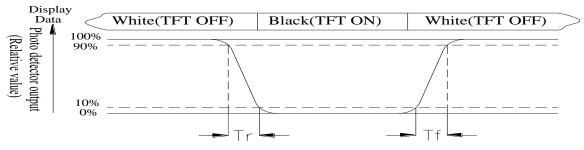
After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.





Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, Tr, is the time between photo detector output intensity changed from 90% to 10%. And fall time, Tf, is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

Contrast ratio (CR) = $\frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$

Note 5: White $Vi = Vi50 \pm 1.5V$

Black Vi = Vi50 ± 2.0 V

"±" means that the analog input signal swings in phase with VCOM signal.

"±" means that the analog input signal swings out of phase with VCOM signal.

The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

Note 6: Definition of color chromaticity (CIE 1931) Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.



12.Reliability

Content of Reliability Test (Wide temperature, $-20^{\circ}C \sim 70^{\circ}C$)

Environmental Test

Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60℃,90%RH max	60℃,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20℃/70℃ 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact) ,±800v(air), RS=330Ω CS=150pF 10 times	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.



13.Initial Code For Reference void Initial RA8875() { **RES** = 1: Delay1ms (10); //Active low RES = 0: Delay1ms (50); **RES** = 1: Delay1ms (100); LCD CmdWrite(0x88); LCD DataWrite(0x0b); LCD_DataRead(); Delay1ms(1); LCD CmdWrite(0x89): LCD DataWrite(0x02); LCD DataRead(); Delay1ms(1); LCD_CmdWrite(0x10); LCD DataWrite(0x0F); LCD_CmdWrite(0x04); LCD_DataWrite(0x81); Delay1ms(1); LCD_CmdWrite(0x14); LCD DataWrite(0x63); LCD_CmdWrite(0x15); LCD DataWrite(0x03); LCD_CmdWrite(0x16); LCD_DataWrite(0x03); LCD CmdWrite(0x17); LCD DataWrite(0x02): LCD CmdWrite(0x18); LCD_DataWrite(0x00); LCD CmdWrite(0x19); LCD_DataWrite(0xdf); LCD CmdWrite(0x1a); LCD_DataWrite(0x01); LCD_CmdWrite(0x1b); LCD DataWrite(0x14); LCD_CmdWrite(0x1c); LCD_DataWrite(0x00); LCD CmdWrite(0x1d): LCD_DataWrite(0x06);

LCD CmdWrite(0x1e); LCD_DataWrite(0x00);



}

LCD_CmdWrite(0x1f); LCD_DataWrite(0x01);

LCD_CmdWrite(0x30); LCD_DataWrite(0x00); LCD_CmdWrite(0x31); LCD_DataWrite(0x00); LCD_CmdWrite(0x34); LCD_DataWrite(0x1F); LCD_CmdWrite(0x35); LCD_DataWrite(0x03); LCD_CmdWrite(0x32); LCD_DataWrite(0x00); LCD_CmdWrite(0x33); LCD_DataWrite(0x00); LCD_CmdWrite(0x36); LCD_DataWrite(0xdf); LCD_CmdWrite(0x37); LCD_DataWrite(0x01);



		Page: 1			
	LCM Sampl	e Estimate Feedback Sheet			
Module Number :	Module Number:				
1 · Panel Specification :					
1. Panel Type:	Pass	□ NG ,			
2. View Direction :	□ Pass	□ NG ,			
3. Numbers of Dots :	□ Pass	□ NG ,			
4. View Area :	□ Pass	□ NG ,			
5. Active Area:	□ Pass	□ NG ,			
6.Operating Temperature :	Pass	□ NG ,			
7.Storage Temperature :	Pass	□ NG ,			
8.Others :		·			
2 · Mechanical Specification					
1. PCB Size :	Pass	□ NG ,			
2.Frame Size :	Pass	□ NG ,			
3.Materal of Frame :	Pass	□ NG ,			
4.Connector Position :	□ Pass	□ NG ,			
5.Fix Hole Position :	□ Pass	□ NG ,			
6.Backlight Position :	□ Pass	□ NG ,			
7. Thickness of PCB :	□ Pass	□ NG ,			
8. Height of Frame to PCB :	Pass	□ NG ,			
9.Height of Module :	□ Pass	□ NG ,			
10.Others :	□ Pass	□ NG ,			
3 · <u>Relative Hole Size</u> :					
1.Pitch of Connector :	Pass	□ NG ,			
2.Hole size of Connector :	Pass	□ NG ,			
3.Mounting Hole size :	Pass	□ NG ,			
4.Mounting Hole Type :	□ Pass	□ NG ,			
5.Others :	Pass	□ NG ,			
4 · Backlight Specification					
1.B/L Type:	□ Pass	□ NG ,			
2.B/L Color :	□ Pass	□ NG ,			
3.B/L Driving Voltage (Refere	3.B/L Driving Voltage (Reference for LED Type) : □ Pass □ NG ,				
4.B/L Driving Current :	Pass	□ NG ,			
5.Brightness of B/L :	□ Pass	□ NG ,			
6.B/L Solder Method :	□ Pass	□ NG ,			
7.Others :	Pass	□ NG ,			
	•				

>> Go to page 2 <<



Page: 2

		T age. 7	
Module Number :	<u> </u>		
5 · Electronic Characteristics of Module :			
1.Input Voltage :	□ Pass	□ NG ,	
2.Supply Current :	□ Pass	□ NG ,	
3.Driving Voltage for LCD :	□ Pass	□ NG ,	
4.Contrast for LCD :	□ Pass	□ NG ,	
5.B/L Driving Method :	□ Pass	□ NG ,	
6.Negative Voltage Output :	□ Pass	□ NG ,	
7.Interface Function :	□ Pass	□ NG ,	
8.LCD Uniformity :	□ Pass	□ NG ,	
9.ESD test :	□ Pass	□ NG ,	
10.Others :	□ Pass	□ NG ,	

6 • <u>Summary</u> :

Sales signature : _____

Customer Signature : _____

Date : / /